# 504456399 07/13/2017

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4503100

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HSIAO-TSUNG YEN	05/17/2017
CHENG-WEI LUO	05/17/2017
YUH-SHENG JEAN	05/17/2017
TA-HSUN YEH	05/17/2017

### **RECEIVING PARTY DATA**

Name:	REALTEK SEMICONDUCTOR CORPORATION
Street Address:	NO. 2, INNOVATION ROAD II, HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15649503

### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	ANTHONY KING
SIGNATURE:	/Anthony King/
DATE SIGNED:	07/13/2017

**Total Attachments: 2** 

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PATENT REEL: 043002 FRAME: 0880

504456399

# **ASSIGNMENT**

WHEREAS, I(we), HSIAO-TSUNG YEN, CHENG-WEI LUO, YUH-SHENG JEAN and TA-HSUN YEH whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled.

#### Semiconductor Element

(hereinafter referred to as the INVENTION) for which an application	n for United States Let	ters Patent /Utility Patent
is executed on even date herewith unless at least one of the follows	ing is checked:	
☐ United States Design Patent was		
☐ executed on:		
☐ filed on: Serial No.:		
🗖 established by PCT International Patent Application No.:	filed:	designating the
United States of America		· · · · ·
issued on as U.S. Patent No.:		

WHEREAS, REALTEK SEMICONDUCTOR CORPORATION whose post office address is No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan (R.O.C.) hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial possessions;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment;

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said Invention, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said Invention, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the Invention that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

PATENT REEL: 043002 FRAME: 0881

	105A-036US (EN16RT010US)
ASSIGNOR NAME HSIAO-TSUNG YEN	13F., No.27, Dongguang Rd., East Dist., Hsinchu City 300, Taiwan (R.O.C.)
Signature of Assignor HSiau-Tsung Ten	Date of Signature May 17, 2017
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)
ASSIGNOR NAME	Address
CHENG-WEI LUO	No.62, Ln. 173, Minxiang St., East Dist., Hsinchu City 300, Taiwan (R.O.C.)
(Lugney Wei Luw Signature of Assignor	Date of Signature May 17, 2017
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)
L ASSIGNOR NAME	Address
ASSIGNOR NAME YUH-SHENG JEAN	Address No.373, Xuefu E. Rd., Zhudong Township, Hsinchu County 310, Taiwan (R.O.C.)
YUH-SHENG JEAN	No.373, Xuefu E. Rd., Zhudong Township,
YUH-SHENG JEAN	No.373, Xuefu E. Rd., Zhudong Township, Hsinchu County 310, Taiwan (R.O.C.)
YUH-SHENG JEAN  Signature of Assignor Yuh-Shey Jean	No.373, Xuefu E. Rd., Zhudong Township, Hsinchu County 310, Taiwan (R.O.C.)  Date of Signature  May 17, 2017
Signature of Assignor  Name of Witness (optional)  Signature of Witness (optional)	No.373, Xuefu E. Rd., Zhudong Township, Hsinchu County 310, Taiwan (R.O.C.)  Date of Signature  May 17, 2017  Name of Witness (optional)  Signature of Witness (Optional)
Signature of Assignor Witness (optional)  YUH-SHENG JEAN  Signature of Assignor Witness (optional)	No.373, Xuefu E. Rd., Zhudong Township, Hsinchu County 310, Taiwan (R.O.C.)  Date of Signature
Signature of Assignor Name of Witness (optional)  Signature of Witness (optional)  ASSIGNOR NAME	No.373, Xuefu E. Rd., Zhudong Township, Hsinchu County 310, Taiwan (R.O.C.)  Date of Signature
Signature of Assignor  Name of Witness (optional)  Signature of Witness (optional)  ASSIGNOR NAME TA-HSUN YEH  TA-HSUN YEH	No.373, Xuefu E. Rd., Zhudong Township, Hsinchu County 310, Taiwan (R.O.C.)  Date of Signature  May 17, 2017  Nume of Witness (optional)  Signature of Witness (Optional)  Address  12F2, No.389, Sec. 2, Gongdao 5th Rd., East Dist., Hsinchu City 300, Taiwan (R.O.C.)  Date of Signature

**PATENT REEL: 043002 FRAME: 0882** 

**RECORDED: 07/13/2017**